

PRODUCT SPECIFICATIONS

GS240128A-Q-BSXTSWW-100

V1.3

May 12, 2009

 Eastertronic LCD Group

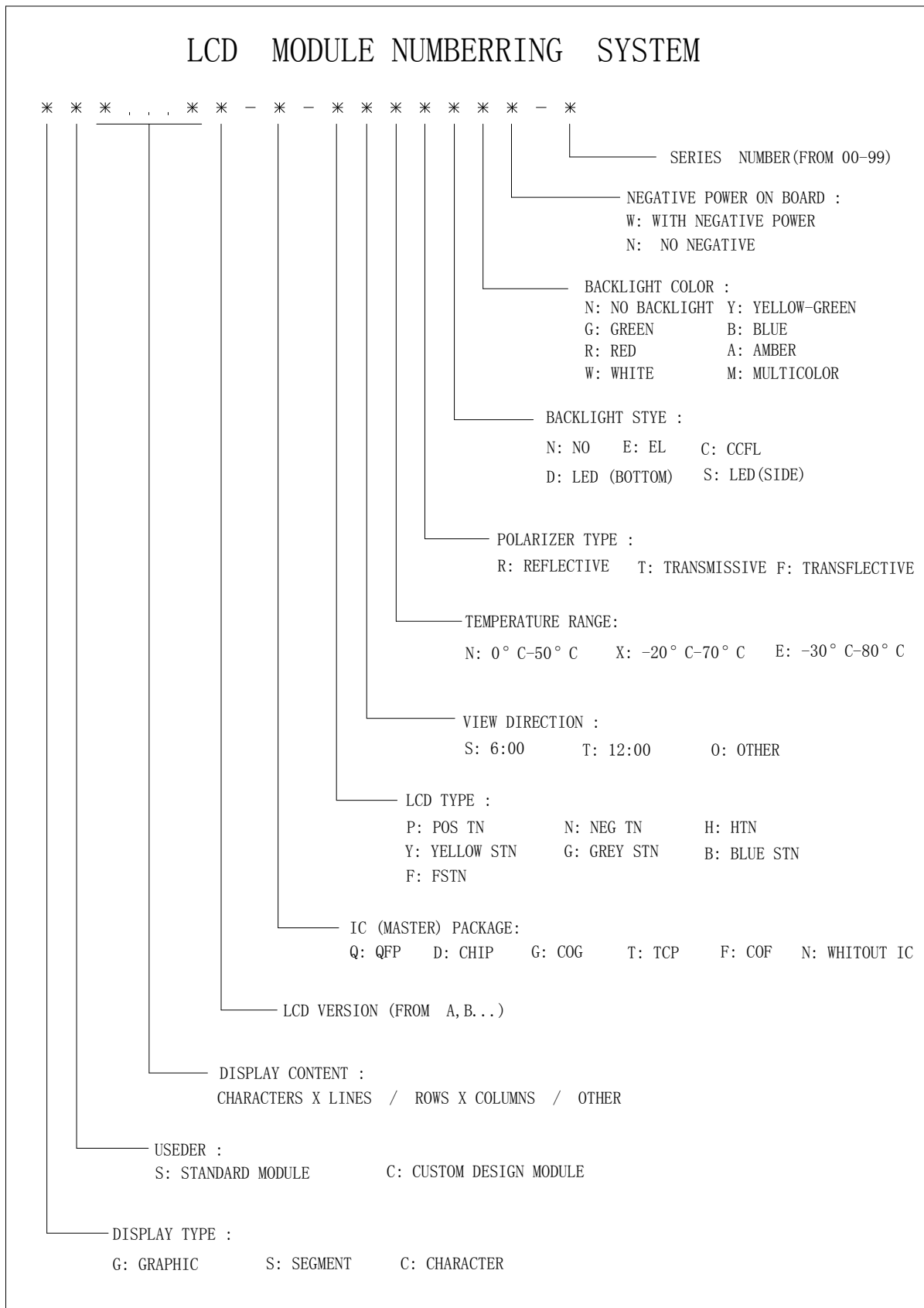
REVISION RECORD

VERSION	DESCRIPTION	Page	DATE
V1.0			March25,2008
V1.1	Modify the value of Vdd-Vo		Aug 12,2008
V1.2	Add quality units and revise the value of Vdd-V0 from 16.0V to 16.5V	15,8	Apr 27, 2009
V1.3	Modify the value of Vdd-V0 from 16.5V to 15.5V	8	May 12, 2009

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1. LCD Module Numbering System



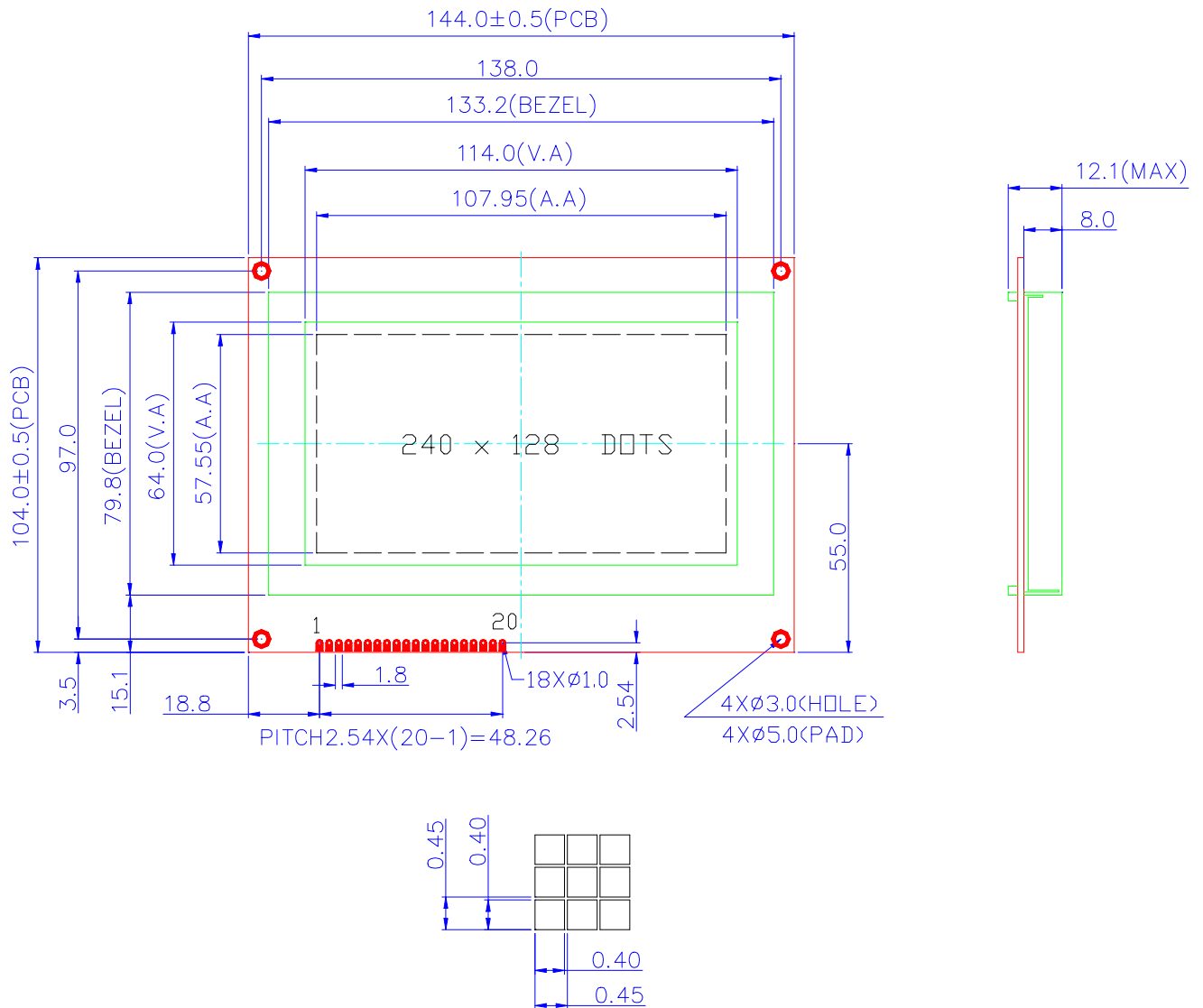
2. TYPE NUMBER AND DESCRIPTION

Type Number	:	GS240128A-Q-BSXTSWW-100
Description	:	240 X 128 DOTS
LCD Panel	:	Blue STN, Negative, Transmissive
Viewing angle	:	6H
Duty and Bias	:	1/128 duty; 1/12 bias
Backlight	:	Side, White LED
Logic Voltage	:	5.0V
Operating Temperature	:	-20°C--70°C
Storage Temperature	:	-30°C--80°C
Controller	:	T6963C
Package	:	SMT
DC-DC convertor	:	With

3. MECHANICAL SPECIFICATIONS:

ITEM	STANDARD VALUE	UNIT
DISPLAY CONTENT	240 H X 128 V DOTS	
MODULE DIMENSION	144.0 (W) X 104.0 (H) X 12.1 (H)	mm
DISPLAY AREA	114.0 (W) X 64.0(H)	mm
DOT SIZE	0.40 (W) X 0.40 (H)	mm
DOT PITCH	0.45 (W) X 0.45 (H)	mm

MODULE DIMENSION DRAWING

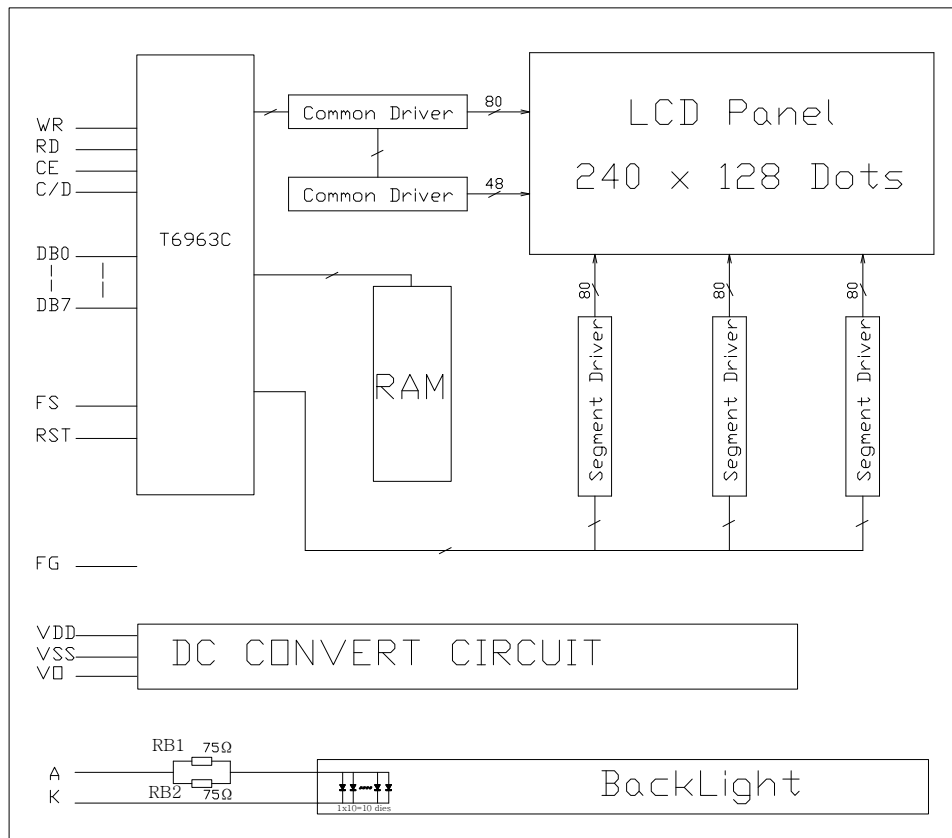


4. ELECTRICAL BLOCK DIAGRAM

4.1 Pin Definition

PIN	SYMBOL	FUNCTION
1	FG	Frame Ground
2	VSS	Power Supply (GND)
3	VDD	Power Supply (+5.0V)
4	V0	Operating Voltage for LCD
5	/WR	Data Write into T6963C, L active
6	/RD	Data Read from T6963C, L active
7	/CE	Chip Select
8	C/D	Command / Data Select
9	RST	Reset
10-17	DB0-DB7	Data Bus
18	FS	Font Select, H: 6x8; L: 8x8
19	A	Power Supply For Backlight (+)
20	K	Power Supply For Backlight (-)

4.2 Electrical Block Diagram



5. ABSOLUTE MAXIMUM RATINGS

5.1 Electrical Maximum Ratings

Characteristic	Symbol	Value	Unit	Note
Operating Voltage	V _{DD}	-0.3~+7.0	V	NOTE*1
Supply Voltage	V _{EE}	V _{DD} -19.0~V _{DD} +0.3	V	NOTE*4
Driver Supply Voltage	V _B	-0.3~V _{DD} +0.3	V	NOTE*1,3
	V _{LCD}	V _{EE} -0.3~V _{DD} +0.3	V	NOTE*2
Operating Temperature	T _{OPR}	-20~+70	°C	
Storage Temperature	T _{STG}	-30~+80	°C	

NOTE*1. Based on V_{SS}=0V .

NOTE*2 Applies the same supply voltage to V_{EE1} and V_{EE2}. V_{LCD}=V_{DD}-V_{EE}

NOTE*3 Applies to RSTB,CE,RD,WR,C/D, DB0~DB7.

NOTE*4 Applies to V1,V2,V3,V4,V5.

5.2 Environmental Conditions

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Operating Temp	Topr	-	-20	70	deg C
Storage Temp	Ttsg	-	-30	80	deg C

6. ELECTRICAL SPECIFICATIONS

6.1 Electrical Characteristics at Ta=25 deg C, V_{dd} = 5V + / - 5%

ITEM	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
Supply Voltage (logic)	V _{dd} -V _{ss}	-	4.5	5.0	5.5	V
Supply Voltage (LCD)	V _{dd} -V ₀	V _{dd} = 5V	15.0	15.5	16.0	V
Input signal voltage (for E, DB0-7,R/W,RS)	V _{ih}	"H" level	2.8	-	V _{dd}	V
	V _{il}	"L" level	0	-	0.8	V
Output voltage for Logic	V _{oh}	-I _{oh} =0.6mA	V _{dd} -0.3	-	V _{dd}	V
	V _{ol}	I _{ol} =1.6mA	0	-	0.3	
Supply Current	I _{dd}	-	--	20.0	25.0	mA
*Supply Voltage (LED)	V-bl	-	2.9	3.1	3.3	V
*Supply Current (LED)	I _f	-	-	150	200	mA
*Peak forward current(B/L)	I _{fp}	1 mseo pulse 10% Duty Cycle	-	-	600	mA
*Power dissipation(B/L)	P _d	-	-	-	620	mW

*For operation above 25°C, the I_f, I_{fp}&P_d must be derated, the current derating is -3.6mA/°C for DC drive and -8.6mA/°C for pulse drive,the power dissipation is -11.16 mW /°C.The Blacklight working current must not more than 60% of the I_{fmax} or I_{fpmax} according to the working temperature

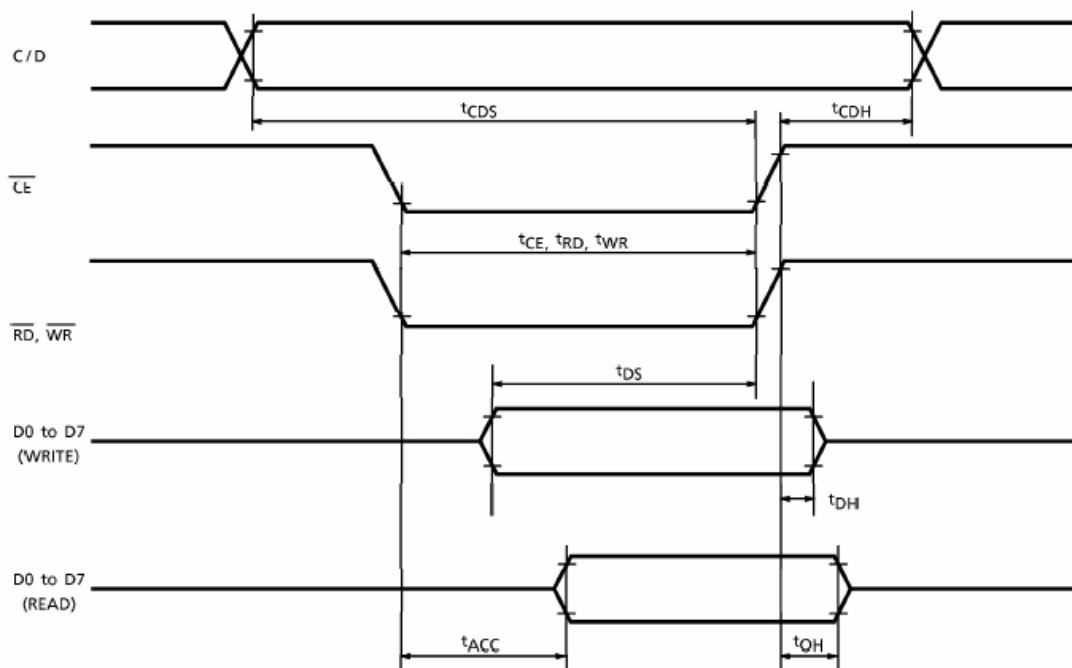
6.2 Timing Specifications

TEST CONDITIONS (Unless otherwise noted, $V_{DD} = 5.0V \pm 10\%$, $V_{SS} = 0V$, $T_a = -20$ to $70^\circ C$)

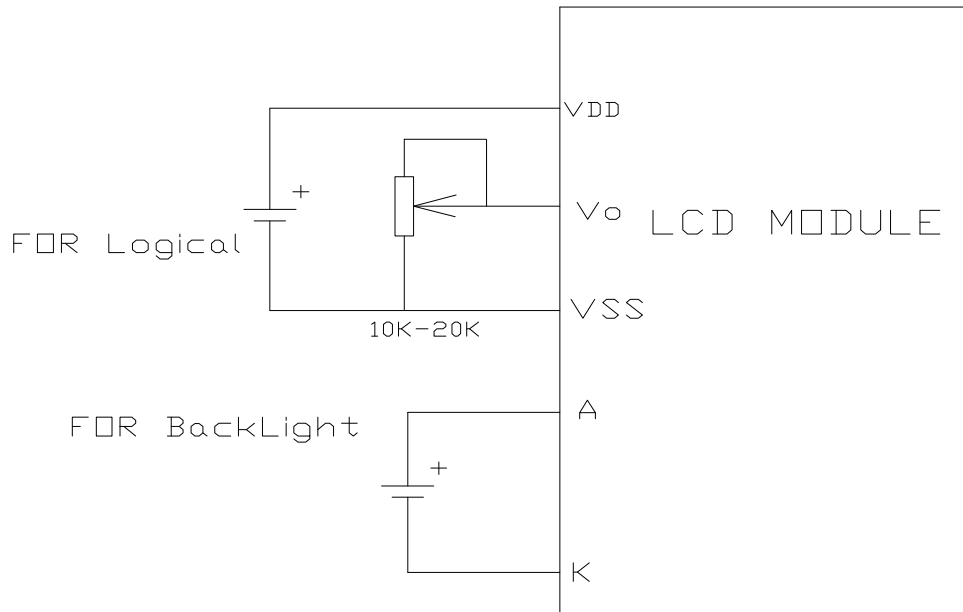
ITEM	SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
Operating Frequency	f_{SCP}	$T_a = -10 \sim 70^\circ C$	—	2.75	MHz
SCP Pulse Width	t_{CWH}, t_{CWL}	—	150	—	ns
SCP Rise / Fall Time	t_r, t_f	—	—	30	ns
LP Set-up Time	t_{LSU}	—	150	290	ns
LP Hold Time	t_{LHD}	—	5	40	ns
Data Set-up Time	t_{DSU}	—	170	—	ns
Data Hold Time	t_{DHD}	—	80	—	ns
FR Delay Time	t_d	—	0	90	ns
CDATA Set-up Time	t_{CSU}	—	450	850	ns
CDATA Hold Time	t_{CHD}	—	450	950	ns

Switching Characteristics (2)

Bus Timing



7. POWER SUPPLY FOR LCD MODULE



8. ELECTRO-OPTICAL CHARACTERISTIC

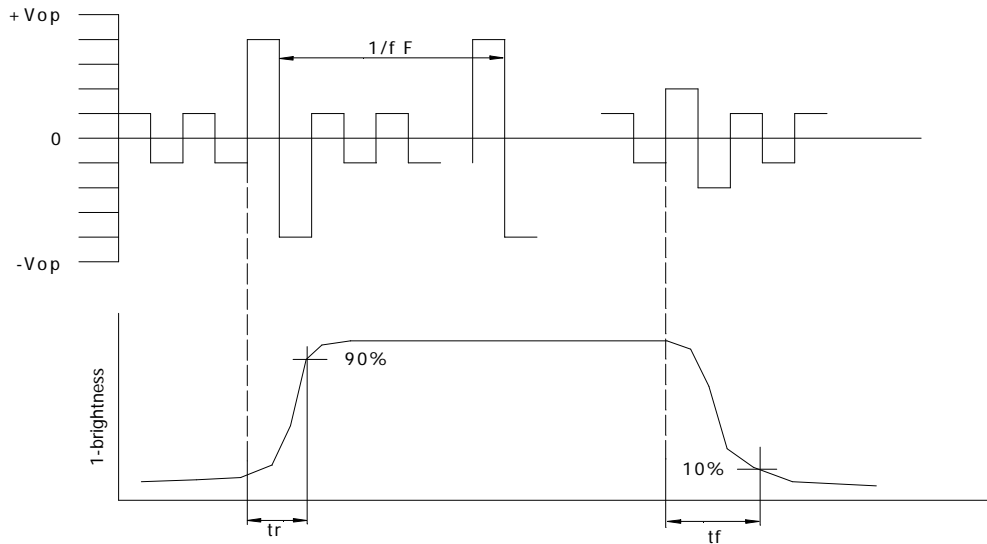
ITEM	SYMBOL	CONDI TION	MIN.	TYP.	MAX.	UNIT	REF.
Contrast	CR	25°C	--	12	--		Note1
Rise Time	tr	25°C	--	160	240	ms	Note2
Fall Time	tf	25°C	--	100	150	ms	note 2
Viewing Angle	$\theta 1 - \theta 2$	25°C	--	--	60	DEG	Note 3
	$\varnothing 1, \varnothing 2$		-40	--	40		
Frame Frequency	Ff	25°C	--	64	--	Hz	note 2

Note(1): Contrast ratio is defined under the following condition:

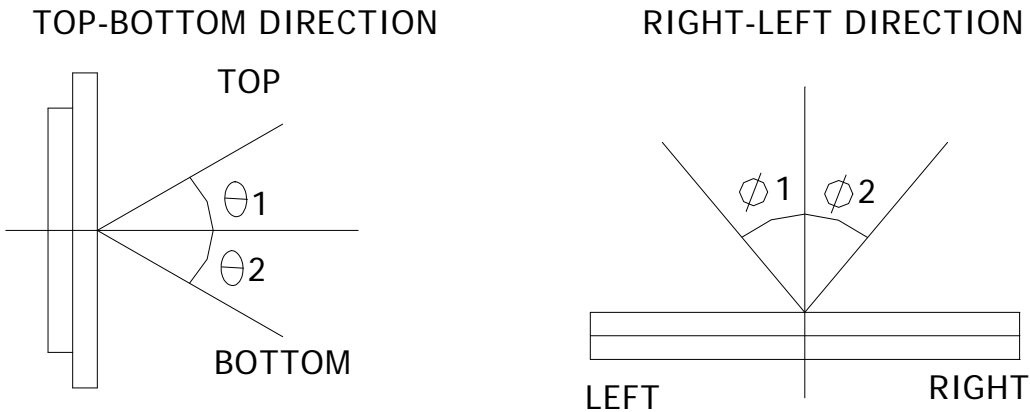
$$CR = \frac{\text{brightness of selected condition}}{\text{brightness of non-selected condition}}$$

- Temperature-----25C
- Frame Frequency-----64Hz
- Viewing angle----- $\theta = 0, \varnothing = 0$
- Operating Voltage---15.5V

Note(2): definition of response time:

**Condition:**

- (a). Temperature-----25C
- (b). Frame Frequency-----64Hz
- (c). Viewing angle----- $\theta = 0, \phi = 0$
- (d). Operating Voltage---15.5V

Note(3): definition of view angle:

9. INSTRUCTION TABLE

COMMAND DEFINITIONS

COMMAND	CODE	D1	D2	FUNCTION
REGISTERS SETTING	00100001	X address	Y address	Set Cursor Pointer
	00100010	Data	00H	Set Offset Register
	00100100	Low address	High address	Set Address Pointer
SET CONTROL WORD	01000000	Low address	High address	Set Text Home Address
	01000001	Columns	00H	Set Text Area
	01000010	Low address	High address	Set Graphic Home Address
	01000011	Columns	00H	Set Graphic Area
MODE SET	1000X000	—	—	OR mode
	1000X001	—	—	EXOR mode
	1000X011	—	—	AND mode
	1000X100	—	—	Text Attribute mode
	1000XXX	—	—	Internal CG ROM mode
	10001XXX	—	—	External CG RAM mode
DISPLAY MODE	10010000	—	—	Display off
	1001XX10	—	—	Cursor on, blink off
	1001XX11	—	—	Cursor on, blink on
	100101XX	—	—	Text on, graphic off
	100110XX	—	—	Text off, graphic on
	100111XX	—	—	Text on, graphic on
CURSOR PATTERN SELECT	10100000	—	—	1-line cursor
	10100001	—	—	2-line cursor
	10100010	—	—	3-line cursor
	10100011	—	—	4-line cursor
	10100100	—	—	5-line cursor
	10100101	—	—	6-line cursor
	10100110	—	—	7-line cursor
	10100111	—	—	8-line cursor
DATA AUTO READ / WRITE	10110000	—	—	Set Data Auto Write
	10110001	—	—	Set Data Auto Read
	10110010	—	—	Auto Reset
DATA READ / WRITE	11000000	Data	—	Data Write and Increment ADP
	11000001	—	—	Data Read and Increment ADP
	11000010	Data	—	Data Write and Decrement ADP
	11000011	—	—	Data Read and Decrement ADP
	11000100	Data	—	Data Write and Nonvariable ADP
	11000101	—	—	Data Read and Nonvariable ADP
SCREEN PEEK	11100000	—	—	Screen Peek
SCREEN COPY	11101000	—	—	Screen Copy

X : invalid

DESCRIPTION OF T6963C

PLEASE REFER TO DATESHEET OF T6963C

10. PRECAUTION FOR USING LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handling,

- (1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel off or bubble.
- (2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface. Wipe gently with cotton. Chamois or other soft material soaked in petroleum benzin.
- (3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.
- (4). Glass can be easily chipped or cracked from rough handling, especially at corners and edges.
- (5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

- (1). Do not tamper in any way with the tabs on the tabs on the metal frame.
- (2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.
- (3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).
- (4). When mounting a LCM make sure that the PCB is not under any tress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- (5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing piels.

2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

- (1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- (2). The modules should be kept in antistatic bags or other containers resistant to static for storage.

(3). Only properly grounded soldering irons should be used.

(4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

(5). The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

(6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

2.3. Soldering

(1). Solder only to the I/O terminals.

(2). Use only soldering irons with proper grounding and no leakage.

(3). Soldering temperature: $280\text{ }^{\circ}\text{C} \pm 10^{\circ}\text{C}$

(4). Soldering time: 3 to 4 sec.

(5). Use eutectic solder with resin flux fill.

(6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4. Operation

(1). The viewing angle can be adjusted by varying the LCD driving voltage V_0 .

(2). Driving voltage should be kept within specified range; excess voltage shortens display life.

(3). Response time increases with decrease in temperature.

(4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".

(5). Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".

2.5. Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

2.6. Limited Warranty

Unless otherwise agreed between EASTERNTRONIC and customer, EASTERNTRONIC will replace or repair any of its LCD and LC, which is found to be defective electrically and visually when inspected in accordance with EASTERNTRONIC acceptance standards, for a period on one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of EASTERNTRONIC is limited to repair and/or replacement on the terms set forth above. EASTERNTRONIC will not responsible for any subsequent or consequential events

11. Quality units

11.1 Purpose

This standard for quality assurance should define the quality of LCD module products to customer by EASTERNTRONIC LCD GROUP.

11.2 Scope

This document defines general provisions as well as inspection standards for LCD module supplied by EASTERNTRONIC LCD GROUP, except for those with special requirements from customer.

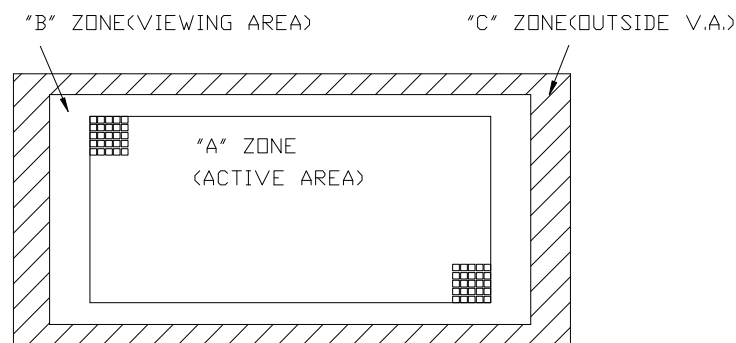
11.3 Definition

11.3.1 Definition of area

A Zone: Active area.

B Zone: Viewing area

C Zone: Outside viewing area.



11.3.2 Definition of size

Large size(L): 1~6 pcs LCD screens are cut out of from each 14"×16" mother glass.

Middle size(M): 7~50 pcs LCD screens are cut out of from each 14"×16" mother glass.

Small size(S): more than 50 pcs LCD screens are cut out of from each 14"×16" mother glass.

11.4 Quality Specification

11.4.1 Conditions of Cosmetic Inspection

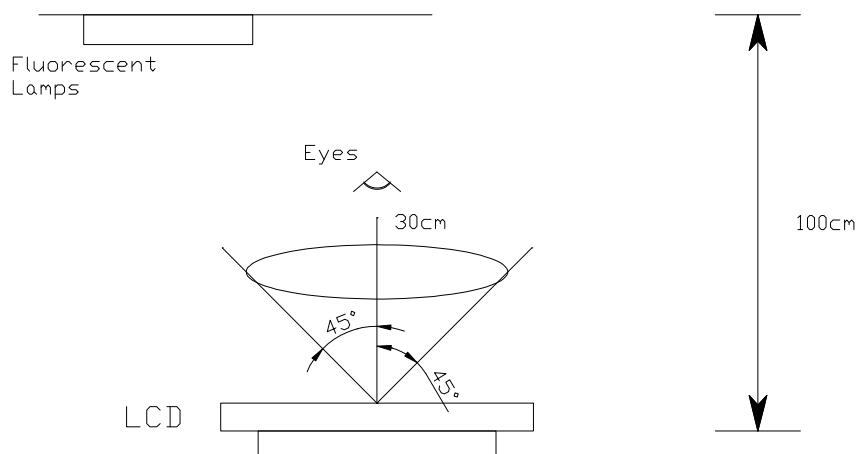
11.4.1 Test should be conducted under the following conditions:

Ambient temperature : $22 \pm 5^{\circ}\text{C}$.

Ambient humidity: $65 \pm 20\% \text{RH}$

Ambient Luminance: 40-watt fluorescent lamp.

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under fluorescent light. Distance between LCD and fluorescent lamps should be 100 cm or more. Viewing direction for inspection is 45° from vertical against LCD.



11.4.1.2 When test the model of transmissive product must add the reflective plate.

11.4.2 Sampling plan

Unless otherwise agreed in writing, the sampling inspection shall be applied to the incoming inspection of customer.

- Lot size: Quantity of shipment lot per model
- Sampling type: Normal inspection, single sampling
- Sampling Level: Level II
- Sampling table: GB/T2828.1.1 (GB-national standard of China)

11.4.3 Classification of defects and Acceptable quality level

Defects and classified as either a major or minor defect defined as follows:

- Major defect: It is a defect that is likely to result in failure or to reduce materially the usability of the product for the intended function.
- Minor defect: It is a defect that will not result in functioning problem with deviation classification.

The AQL for major and minor defects is defined as follows:

Partition	Definition	AQL
Major defect	Functional defective as product	0.4
Minor defect	Satisfy all functions as product but not satisfy cosmetic standard	1.0

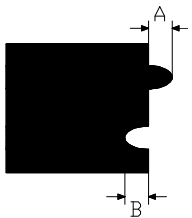
11.4.4 Applicable instrument

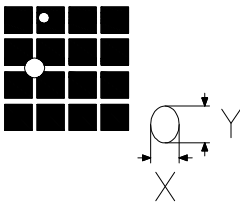
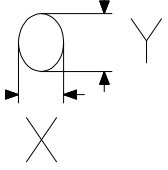
- LCD module tester
- Multimeter
- Caliper
- Defect size filming standard

11.4.5 Inspection quality criterion

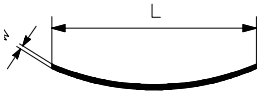
11.4.5.1 LCD panel part

The inspection specification as following list:

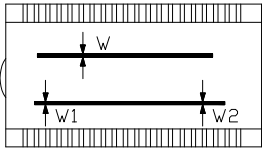
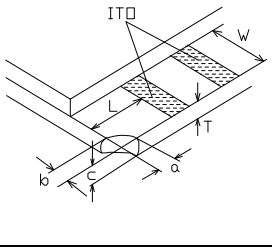
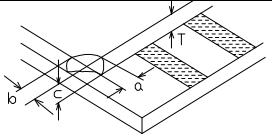
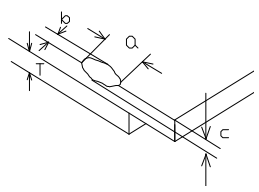
Classify	Item	Description of defects	Inspection criterion		Drawing specification
Major defect	1.Non-display	Product no function	Not accept		
	2.LCD with wrong view direction`	Difference in Spec.	Not accept		
	3.Segment missing	Part or all pattern do not light up	Not accept		
	4.Occur high current	Current exceed designed value	Not accept		
	5. LC leakage	LC does not fulfill the glass cell	Not accept		
	6.Deviation from drawing	LCM Dimension difference from drawing and over tolerance	According to dimensions noted in the specification		
	7.Wrong type applied	Wrong polarizer attachment	Not accept		
		Pin attached wrong type applied	Not accept		
8.Incorrect pins quality	Pin attached wrong quantity applied	Not accept			
Minor defect	9.Pattern deformation	Segment fatter or smaller	Dimension (mm)	Acceptable number	
			$A \leq 0.1$	Not count (Should not be connected to next dot)	
			$0.10 < A \leq 0.15$	1 pc / dot (only segment) or less 2 pcs / cell or less (Should not be connected to next dot)	
			$B \leq 0.10$	Not count	
Minor defect	10.Pinholes	Black spot/white spot at activated state	1. large size LCD Accept if can't be found at 1m distance and will not enlarge under electronic test 2. Middle size LCD Diameter(mm) Accept QTY		

			<p> $\Phi \leq 0.15$ Not count $0.15 < \Phi \leq 0.25$ 3 $0.25 < \Phi \leq 0.35$ 1 $\Phi > 0.35$ 0 </p> <p>3. Small size LCD Diameter(mm) Accept QTY</p> <p> $\Phi \leq 0.15$ Not count $0.15 < \Phi \leq 0.25$ 2 $0.25 < \Phi \leq 0.30$ 1 $\Phi > 0.30$ 0 </p> <p>4. For the dot pattern: accept if the area of defect is less than or equal to half of one lattice's</p> <p>5. Only allow one defect in one segment</p> <p>6. The nearest distance allowed between two pinholes is 20mm</p> <p>Remarks: Regarding the product in negative type (including TN, STN and FSTN), with normal driving voltage, the white dot size should be less or equal 0.2mm ($\Phi \leq 0.2$). If the driving voltage is lower 0.3V than the normal voltage, it should be abnormal voltage, it can not judge the white dot base on abnormal voltage.</p>	 <p>$\Phi = (X+Y)/2$</p>
11. Blemishes and foreign matters	Black spot/dust on LCD(non-display)		<p>Positive panel:</p> <p>1.A zone</p> <p>- Large size LCD Accept if can't find at 1m distance and will not enlarge under electronic test:</p> <p>- Middle size LCD Diameter(mm) Accept QTY</p> <p> $\Phi \leq 0.15$ Not count $0.15 < \Phi \leq 0.25$ 3 $0.25 < \Phi \leq 0.35$ 1 $\Phi > 0.35$ 0 </p> <p>- Small size LCD Diameter(mm) Accept QTY</p> <p> $\Phi \leq 0.15$ Not count $0.15 < \Phi \leq 0.25$ 2 $0.25 < \Phi \leq 0.30$ 1 </p>	 <p>$\Phi = (X+Y)/2$</p>

			$\Phi > 0.30$ 0 2.B zone 1.5 times of acceptable largest diameter size of Zone A 3.C zone Notcount. Negative panel: 1. A zone -Large size LCD Diameter(mm) Accept QTY $\Phi \leq 0.15$ Not count $0.15 < \Phi \leq 0.30$ 4 $0.30 < \Phi \leq 0.50$ 1 $\Phi > 0.50$ 0 -Middle&small size LCD Diameter(mm) Accept QTY $\Phi \leq 0.15$ Not count $0.15 < \Phi \leq 0.25$ 3 $\Phi > 0.25$ 0 2. B zone 1.5 times of acceptable largest diameter size of Zone A 3.C zone No count The nearest diatance allowed between two black spot is 20mm	
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	12.Black lines and scratches	Scratch on glass or polarizer surface.And foreign linear matters in LCD	<p>Positive panel:</p> <p>1.A zone - Large size LCD Accept if can't find at 1m distance and will not enlarge under electronic test.</p> <p>-Middle size LCD Diameter(mm) Accept QTY $W \leq 0.02$ Not count $0.02 < W \leq 0.03, L \leq 4$ 2 $0.03 < W \leq 0.05, L \leq 3$ 2 $0.02 < W \leq 0.03, L > 4$ 0 $0.03 < W \leq 0.05, L > 3$ 0 $W > 0.05$ As the spot criteria.</p> <p>-Small size LCD Diameter(mm) Accept QTY $W \leq 0.02$ Not count $0.02 < W \leq 0.03, L \leq 4$ 2 $0.03 < W \leq 0.05, L \leq 2$ 1 $0.02 < W \leq 0.03, L > 4$ 0 $0.03 < W \leq 0.05, L > 2$ 0 $W > 0.05$ As the spot criteria.</p> <p>2.B zone 1.5 times of acceptable largest diameter size of Zone A</p> <p>3.C zone Notcount.</p> <p>Negative panel:</p> <p>1. A zone -Large size LCD Diameter(mm) Accept QTY $W \leq 0.02$ Not count $0.02 < W \leq 0.03, L \leq 5$ 3 $0.03 < W \leq 0.05, L \leq 4$ 2 $0.02 < W \leq 0.03, L > 5$ 0 $0.03 < W \leq 0.05, L > 4$ 0 $W > 0.05$ As the spot criteria.</p> <p>-Middle size LCD Diameter(mm) Accept QTY $W \leq 0.02$ Not count $0.02 < W \leq 0.03, L \leq 4$ 2 $0.03 < W \leq 0.05, L \leq 2$ 2 $0.02 < W \leq 0.03, L > 3$ 0 $0.03 < W \leq 0.05, L > 2$ 0</p>	
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			<p>W>0.05 As the spot criteria. -Small size LCD Diameter(mm) Accept QTY W≤0.02 Not count 0.02< W≤0.03,L≤3 2 0.03< W≤0.05,L≤3 1 0.02< W≤0.03,L>3 0 0.03< W≤0.05,L>2 0 W>0.05 As the spot criteria.</p> <p>2. B zone 1.5 times of acceptable largest diameter size of Zone A</p> <p>3.C zone Not count The nearest distance allowed between two defects is 20mm</p>	
Mintor defect	13. Scratch on PI coating	PI coating scratched	The visible scratch of A zone can not be accepted at 30cm view distance.	
Mintor defect	14. Rainbow	Arches,circular or parallel colorful spread	According to the limit specimen	
Mintor defect	15. Bubbles or wrinkles in polarizer	Bubbles or wrinkles between polarizer and glass	A zone:The visible defect can not be accepted at 30cm view distance. B zone: Not count	
Mintor defect	16. Position of polarizer attachment	Wrong polarizer attachment in position or dimension	Polarizer protruding from edge of glass and exceeding/within the maximum external dimension of LCD	
Mintor defect	17. Ink printing defect	17.1 Ink line/pattern broken	Not accept	

		17.2 Ink pattern/line jagged	Accept if the thick or thin part is less than equal to 25% segment width, or according to the limit specimen				
		17.3 Light leakage	When activated with current white light appears in the position of pinhole or scratch due to ink printing misalignment. According to the pinhole specification.				
		17.4 Ink printing pattern/line uneven	Reject if the thick or thin in more than 1/2W. Reject when $W1-W2 \leq 1/3W$				
Mintor defect	18. Pin defect	18.1 Corrosion or foreign material on terminal legs	Pin incoming defect: oxidized, damage (including pins plating damaged), excess epoxy on bottom glass or terminal legs. Not accept.				
		18.2 Pin deviation over tolerance	According to the specification				
Mintor defect	19. Chipped glass on comer	19.1 Chip in lead contact area.	a	b	c	accept QTY	
			$a \leq 5mm$ $L > 5mm$ m	$b \leq W$	$c \leq T$	3	
		$a < L$ $L < 5mm$ m	$b \leq W$	$c \leq T$	3		
		19.2 Others	Not exceed 1/2 width of seal		$c \leq T$	3	
Mintor defect	20. Glass chip on edge	a	b	c	accept QTY		
		$a \leq 5mm$	Not exceed 1/2 width of seal	$c \leq T$	3		

Mintor defect	21. Clipped electrode pad	21.1 Glass chip on ITO edge	a	b	c	accept QTY	
			$a \leq 4\text{mm}$ (and not exceed 4 ITO terminal)	$b \leq W/4$	$c \leq T$	3	
Mintor defect	22. Mechanical damage	21.2 Glass chip on ITO back	a	b	c	accept QTY	
			$a \leq 5\text{mm}$	$b \leq W/3$	$c \leq T$	3	
Mintor defect	22. Mechanical damage	Extended crack inspector shall attempt to remove the chip with tweezers, re-evaluate if the remaining defect is still a crack or a chip	b		accept QTY		
			$b \leq W/4$		2		
Mintor defect	23. Glass cracks		Not accept				

Remark:
 The minimum space between any 2 defects (spot, dirt) should more than 20mm, and max. allowed defect QTY in total:
 Large size LCD: Zone A ≤ 5 /unit, Zone B ≤ 5 /unit;
 Middle size LCD: Zone A ≤ 3 /unit, Zone B ≤ 3 /unit;
 Small size LCD: Zone A ≤ 2 /unit, Zone B ≤ 2 /unit;

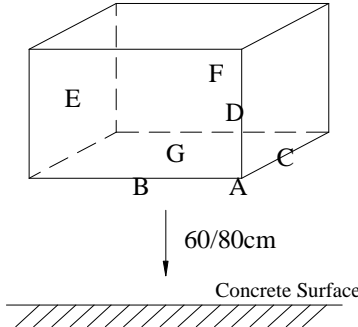
11.4.5.2 Other part

The inspection specification as following list:

NO.	Items	Criterion of defects	AQL
1	Backlight	<ol style="list-style-type: none"> 1. Lumination source flickers. 2. Using spot, lines and contamination standard of LCD to judge the spots or scratches defect on backlight. 3. Not allow unlighted on backlight. 4. Colour and luminance of backlight should correspond its specification. 	<p>Major Minor</p> <p>Major Major</p>
2	PCB,COB	<ol style="list-style-type: none"> 1.COB seal may not have pinholes larger than0.2mm or contamination. 2.COB seal surface may not have pinholes through to the IC. 3. The height of COB should not exceed the height indicated in the assembly diagram. 4. Beyond 2mm of the seal area, there may not have sealant on the PCB. 5.No oxidation or contamination on PCB connector. 6.Parts on PCB should correspond the characteristic,and not allow wrong parts,missing parts or additional parts. 7.The jumper on the PCB should correspond to the characteristic. 8.The solder which gets on bezel,LED pad,zebra pad or screw hole pad should be smoothed down. 	<p>Minor</p> <p>Minor Major</p> <p>Minor</p> <p>Minor Major</p> <p>Minor</p> <p>Major</p>
3	Soldering	<ol style="list-style-type: none"> 1. No unmelted solder pastes on the PCB. 2. No cold solder joints,solder connection missing,oxidation of solder. 3. No short circuits in components on PCB. 	<p>Minor</p> <p>Minor</p> <p>Minor</p>
4	General Appearance	<ol style="list-style-type: none"> 1. No oxidation, contamination, curves,cracks or bends on interface Pin of TCP. 2. No solder residue or solder balls on product. 3. The IC on TCP may not be damaged. 4. The residual rosin or tin oil of soldering(component or chip component) is not turned into brown or black colour. 5. Packing method correspond the specification. 6. Dimension and structure correspond the specification sheet. 7. No dirt and break on the heat seal. 	<p>Minor</p> <p>Minor Major Minor</p> <p>Major Major</p> <p>Major</p>

11.5 Reliability

The LCD module shall not fail the following reliability test.

Item	Condition	Criterion	
High temperature operation	+70°C ± 2°C, 8 hours	1.Total current consumption should be below double of initial value. 2.Cosmetic defects should not be happened	
Low temperature operation	-20°C ± 2°C, 8 hours		
Humidity	Operation		40°C ± 2°C, 93% ± 2% RH, 8 hours
	Storage		40°C ± 2°C, 93% ± 2% RH, 24 hours
High temperature storage	+80°C ± 2°C, 10 hours		
Low temperature storage	-30°C ± 2°C, 10 hours		
Thermal shock storage	-20°C ~ +70°C 60min~60min, 5 cycles		
Vibration test	Amplitude:0.7~1.0mm,frequency:50Hz,30min in each direction(X,Y,Z)		
Shock test	To be measured after dropping from 60cm or 80cm high on the concrete surface in packing state.(weight ≥ 15Kg,dropping height 60cm; Weight < 15Kg,dropping height 80cm) <div style="text-align: center;">  <p style="margin-left: 100px;">Dropping method corner dropping A corner: once</p> <p style="margin-left: 100px;">Edge dropping B,C,D edge: once</p> <p style="margin-left: 100px;">Face dropping E,F,G face: once</p> </div>		
Remark: The function test shall be conducted after 4 hours storage at the normal temperature and humidity after removed from the test chamber.			

12. Declaration of conformity regarding the limitation of dangerous substances

深圳易事通液晶显示模块有限公司**SHENZHEN EASTERNTRONIC LCM CO., LTD.**4F, B3 Building, FuYuan Industrial Zone, FuYong Town,
BaoAn District, ShenZhen, P.R. China**DECLARATION OF CONFORMITY REGARDING THE LIMITATION OF DANGEROUS SUBSTANCES**

WE, SHENZHEN EASTERNTRONIC LCM CO., LTD,

Declare that the product of GS240128A-Q-BSXTSWW-100 complies with:
The directive 2002/95/EC Dated 2003/01/27 regarding the limitation
of dangerous substances, in particular to clause 4 which
forbids the use of the following elements:

- Lead
- Mercury
- Cadmium
- Hexavalent chromium
- Polybrominated biphenyls
- Polybrominated diphenylethers

And to the annex which points out the exempted implementations

To the directive 73/23/eec dated 1973/02/19 and the standard
EN60335-1 regarding prohibition of following elements:

- Oils containing polychlorinated biphenyl
- Asbestos
- Radioactive substances

Name: Ding

SHENZHEN EASTERNTRONIC LCM CO., LTD.

Issued on April 18, 2009

According with the proposal of Technical Adaption Committee (TAC) of
a limit of 0.1% by weight for lead hexavalent chromium, mercury, PBBs
and PBDRs and 0.01% by weight for Cadmium.